

Product Features

- 30 ~ 3000MHz
- High Gain
- High linearity
- SOIC-8 SMD Type package
- Lower manufacturing cost
- -74dBc CSO 79 Channels @ +30dBmV/ch
- -73dBc CTB 79 Channels @ +30dBmV/ch

Applications

- Low Noise Amplifier for CATV
- Cable Modem
- FTTH (G-PON, GE-PON)
- Optical node



Package Type : SOIC-8

Description

AE510 is designed as low cost drive amplifiers for many applications including FTTH, CATV System. This MMIC is based on Gallium Arsenide Enhancement Mode pHEMT which shows low current draw and very low noise. The data in this spec sheet is valid only for 75ohm application. 50ohm data is in a separate spec sheet.

Electrical Specifications

PARAMETER		UNIT	MIN	TYP	MAX	CONDITION
Frequency		MHz	30	-	3000	-
Gain		dB	17 14	19 17	- -	30 ~ 1000MHz 50 ~ 2700MHz
Gain Flatness		dB	-	0.7 2.5	-	30 ~ 1000MHz 50 ~ 2700MHz
Input Return Loss		dB	-	-17	-	-
Output Return Loss		dB	-	-18	-	-
Output IP3		dBm	37	40	-	@ 500MHz/5dBm 2tone
1dB Compression Point		dBm	20	23	-	@500MHz
Noise Figure		dB	-	3.0	4.0	30 ~ 1000MHz
CSO	30 ~ 1004MHz	dBc	-	-74	-69	79 channel, +30dBmV/ch
CTB		dBc	-	-73	-68	
DC Current		mA	-	200	-	Vdd = 5.0V

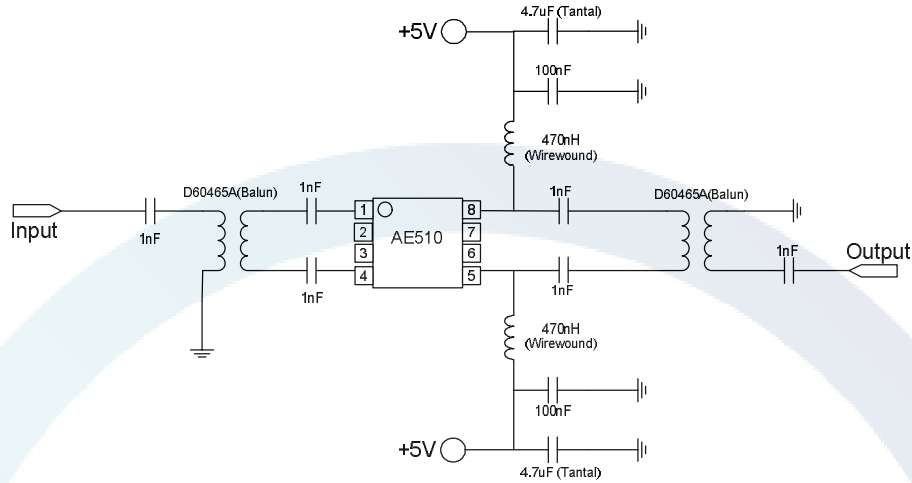
Note

1. Test conditions unless otherwise noted. Test Freq = 500MHz, T=25°C, Vdd=5V, 75Ω system
2. OIP3 measured with 2 tones at an output power of +5dBm/tone separated by 1MHz, Test Freq = 500MHz

Absolute Maximum Ratings

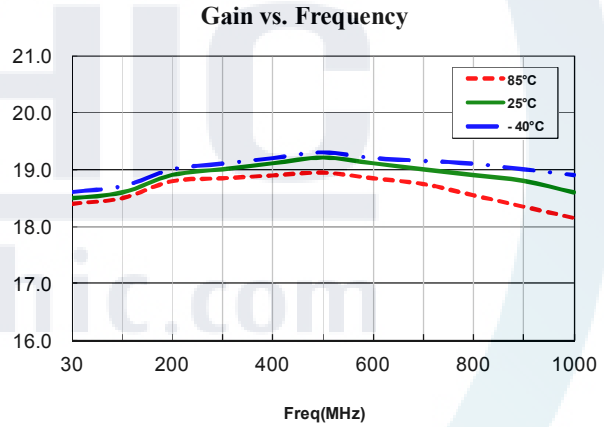
PARAMETER	UNIT	MIN	TYP	MAX
Device Voltage	VDC	-	5	8
Operating Temperature	°C	-40	-	85
Storage Temperature	°C	-40	-	150
ESD Human Body Model	-	-	Class 1A	-
Moisture Sensitivity Level	-	-	MSL1	-
Junction Temperature (Tj)	°C	-	-	180
Thermal Resistance (Rth)	°C/W	-	45	-

Application Circuit @ 30 ~ 1000MHz, 75ohm System, VDD=5V

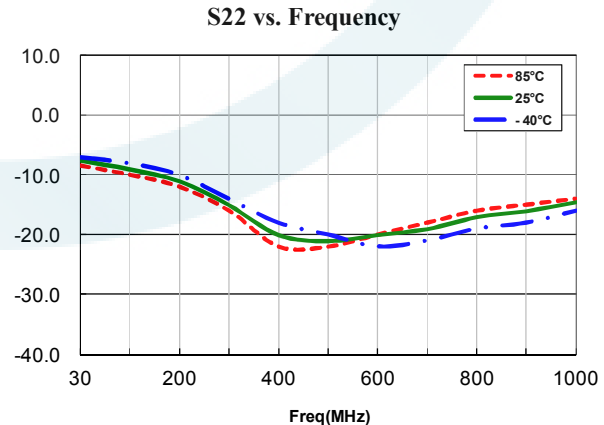
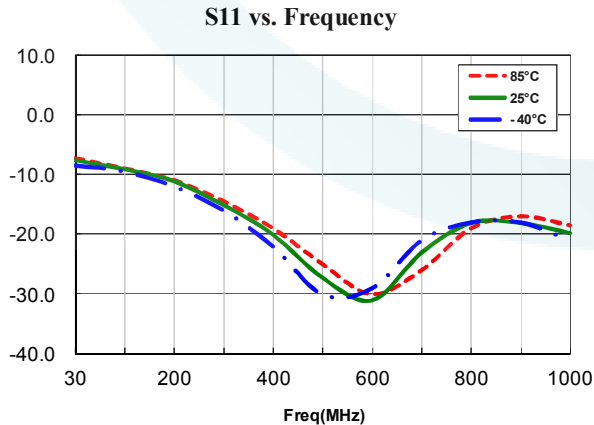


Typical Performance @ VDD=5V, IDS=200mA, T=25°C, 75ohm System

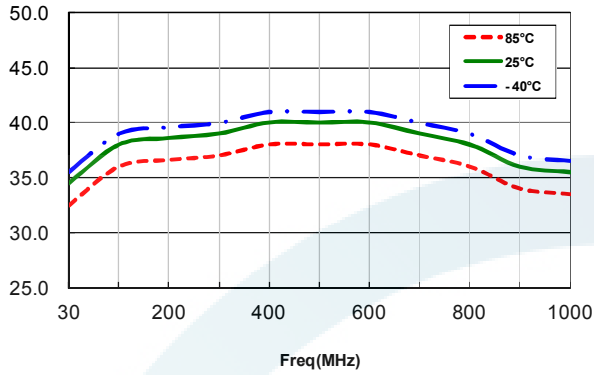
PARAMETER	UNIT	TYPICAL		
Frequency	MHz	30	500	1000
Gain(S21)	dB	18.5	19.2	18.6
Input Return Loss(S11)	dB	-7.5	-27.2	-19.7
Output Return Loss(S22)	dB	-8.0	-18.2	-15.5
Output IP3	dBm	35.2	40	35.8
1dB Compression Point	dBm	21.5	23	22
Noise Figure	dB	2.8	2.9	3.2
CSO*	dBc	-74		
CTB*	dBc	-73		
Current	mA	200		



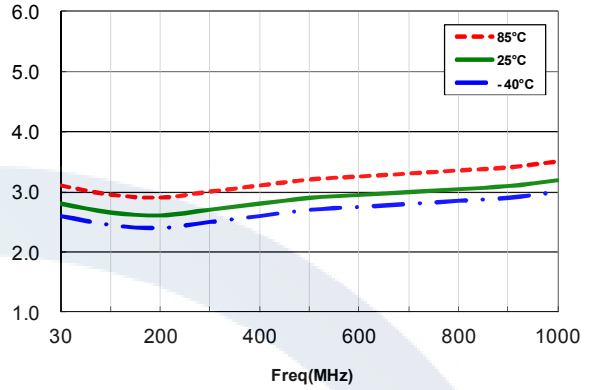
* 79channels_Flat, +30dBmV



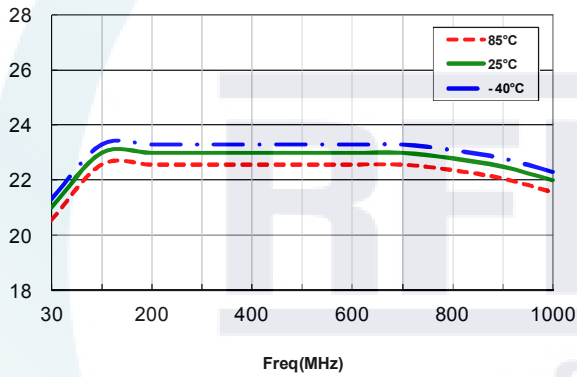
OIP3 vs. Frequency



Noise Figure vs. Frequency

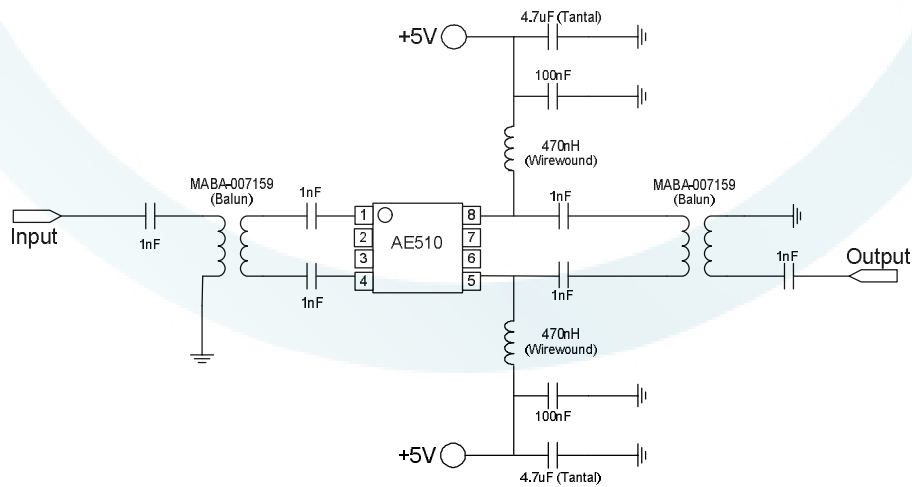


P1dB vs. Frequency



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Application Circuit @ 50 ~ 2700MHz, 75ohm System, VDD=5V

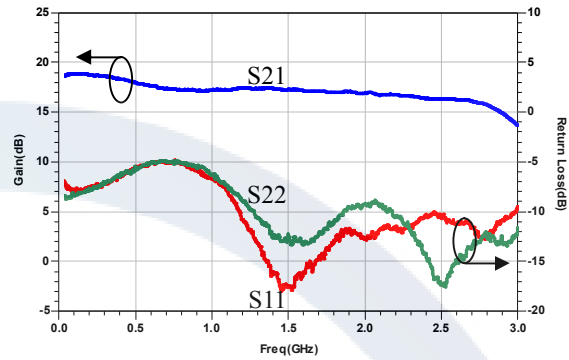


Typical Performance @ VDD=5V, IDS=200mA, T=25°C, 75ohm System

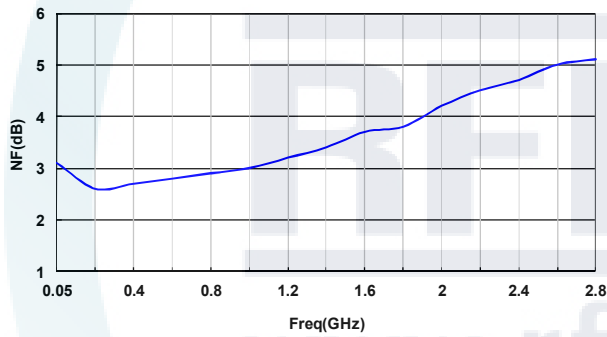
PARAMETER	Units	Typical			
Frequency	GHz	0.05	1	2	2.7
Gain(S21)	dB	18.6	17.2	17	16.1
Input return loss(S11)	dB	-7	-6.7	-13	-12
Output return loss(S22)	dB	-8.5	-6.3	-9.2	-14
Output IP3	dBm	36.7	35.8	36.5	33.5
1dB Compression Point	dBm	21	23	22	18
Noise Figure	dB	2.8	3.2	4.9	5.5
CSO*	dBc	-72			
CTB*	dBc	-69			
Current	mA	200			

* 79channels_Flat, +30dBmV

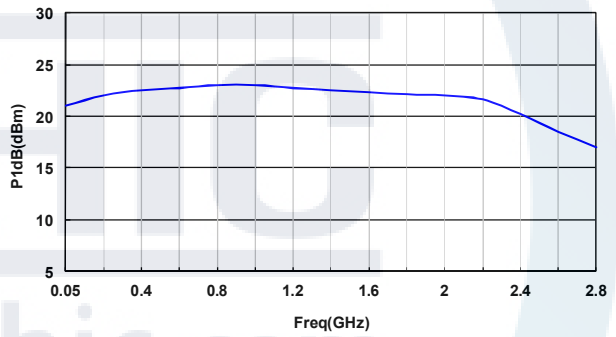
S-Parameter



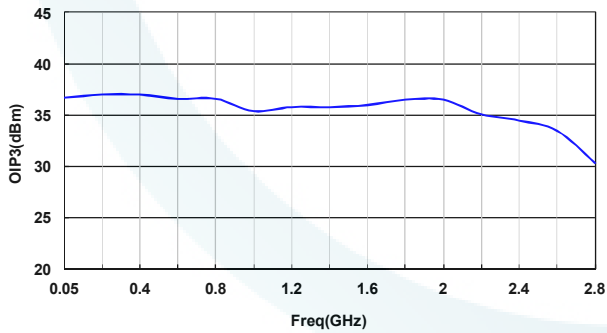
Frequency vs. Noise Figure



Frequency vs. P1dB

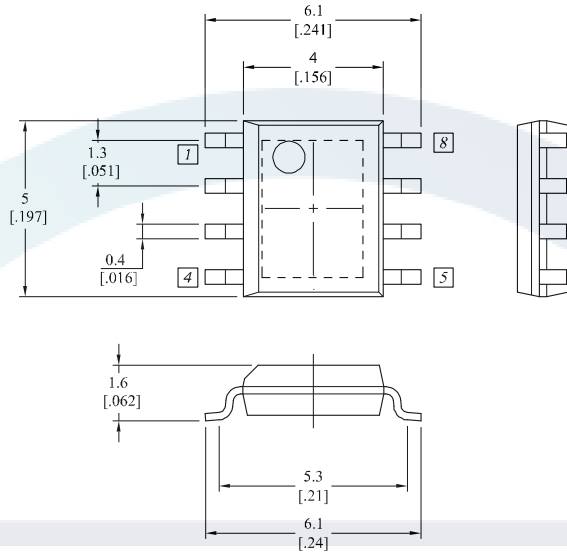


Frequency vs. OIP3



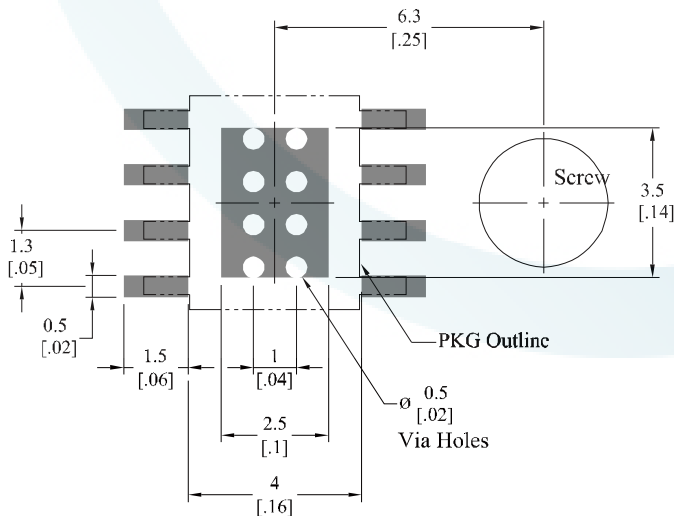
Package Dimensions (Type: SOIC-8)

* Unit: mm[inch] | Tolerance ± 0.2 [.008]



Pin Description			
Pin No	Function	Pin No	Function
1	RF IN(2)	5	RF OUT(1)
2	GND	6	GND
3	GND	7	GND
4	RF IN(1)	8	RF OUT(2)

Recommended Pattern



Mounting Configuration Notes

1. Ground / thermal via holes are critical for the proper performance of this device.
2. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
3. Mounting screws can be added near the part to fasten the board to a heat sink. Ensure that the ground / thermal via hole region contacts the heat sink.
4. Do not put solder mask on the backside of the PCB in the region where the board contacts the heat sink.
5. RF trace width depends upon the PCB material and construction.
6. Use 1 oz. Copper minimum.

Revision History

Part Number	Release Date	Version	Modification	Data Sheet Status
AE510	20140418	1.1	Thermal Resistance (1p)	-
AE510	20131018	1.0	Typical performance (2p)	-
AE510	20130820	0.1	Initial Release of Data sheet	Preliminary



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